

Description

The PT FEEP-EGS uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

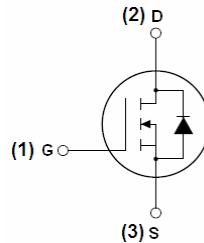
- $V_{DS} = 20V, I_D = 100A$
- $R_{DS(ON)} < 5.5m\Omega @ V_{GS}=4.5V$
- High density cell design for ultra low R_{dson}
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

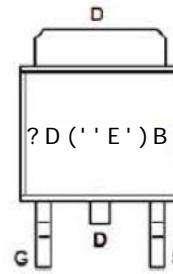
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔV_{ds} TESTED!



Schematic diagram



Marking and pin assignment



TO-252-2L top view

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|-------------|----------------|-----------|------------|----------|
| PT FEEP-EGS | PT FEEP-EGS | TO-252-2L | - | - | - |

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|---------------------|------------|---------------|
| Drain-Source Voltage | V_{DS} | 20 | V |
| Gate-Source Voltage | V_{GS} | ± 12 | V |
| Drain Current-Continuous | I_D | 100 | A |
| Drain Current-Continuous($T_C=100^\circ C$) | $I_D (100^\circ C)$ | 70 | A |
| Pulsed Drain Current | I_{DM} | 350 | A |
| Maximum Power Dissipation | P_D | 60 | W |
| Derating factor | | 0.48 | W/ $^\circ C$ |
| Single pulse avalanche energy (Note 5) | E_{AS} | 200 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 150 | $^\circ C$ |

Thermal Characteristic

| | | | |
|--|-----------|-----|------|
| Thermal Resistance, Junction-to-Case ^(Note 2) | R_{eJC} | 2.1 | °C/W |
|--|-----------|-----|------|

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

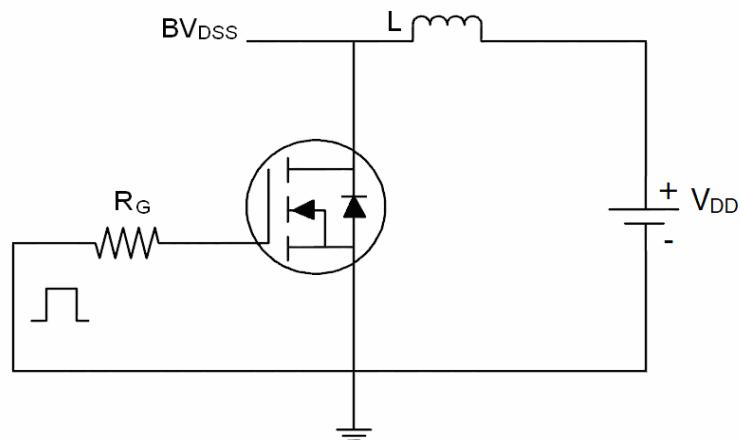
| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------------------|---|------|------|-----------|------------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$ | 20 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{\text{GS}}=\pm 12\text{V}, V_{\text{DS}}=0\text{V}$ | - | - | ± 100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{\text{GS(th)}}$ | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$ | 0.45 | 0.65 | 1.5 | V |
| Drain-Source On-State Resistance | $R_{\text{DS(ON)}}$ | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=40\text{A}$ | - | 4.5 | 5.5 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=30\text{A}$ | | 6.5 | 7.5 | $\text{m}\Omega$ |
| Forward Transconductance | g_{FS} | $V_{\text{DS}}=10\text{V}, I_{\text{D}}=40\text{A}$ | 15 | - | - | S |
| Dynamic Characteristics (Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}}=10\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$ | - | 2000 | - | PF |
| Output Capacitance | C_{oss} | | - | 500 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 200 | - | PF |
| Switching Characteristics (Note 4) | | | | | | |
| Turn-on Delay Time | $t_{\text{d(on)}}$ | $V_{\text{DD}}=10\text{V}, I_{\text{D}}=2\text{A}, R_{\text{L}}=1\Omega$ $V_{\text{GS}}=4.5\text{V}, R_{\text{G}}=3\Omega$ | - | 6.4 | - | nS |
| Turn-on Rise Time | t_{r} | | - | 17.2 | - | nS |
| Turn-Off Delay Time | $t_{\text{d(off)}}$ | | - | 29.6 | - | nS |
| Turn-Off Fall Time | t_{f} | | - | 16.8 | - | nS |
| Total Gate Charge | Q_{g} | $V_{\text{DS}}=10\text{V}, I_{\text{D}}=40\text{A}, V_{\text{GS}}=10\text{V}$ | - | 27 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 6.5 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 6.4 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V_{SD} | $V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}$ | - | | 1.2 | V |
| Diode Forward Current (Note 2) | I_{S} | | - | - | 100 | A |
| Reverse Recovery Time | t_{rr} | $T_{\text{J}} = 25^\circ\text{C}, I_{\text{F}} = 40\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}$ (Note 3) | - | 25 | - | nS |
| Reverse Recovery Charge | Q_{rr} | | - | 24 | - | nC |
| Forward Turn-On Time | t_{ton} | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | |

Notes:

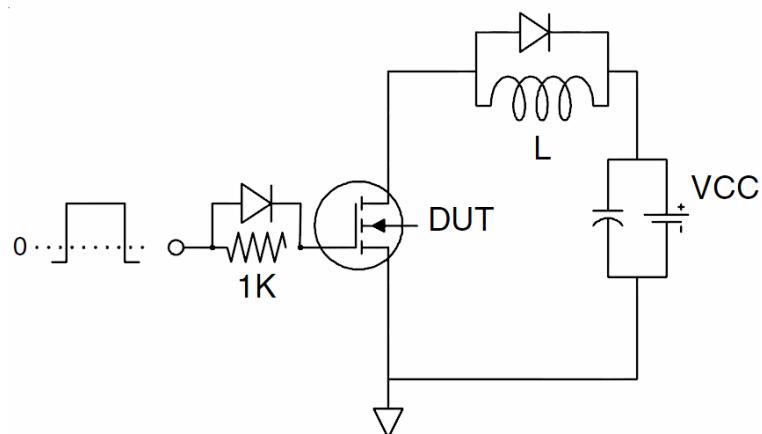
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. E_{AS} condition : $T_j=25^\circ\text{C}, V_{\text{DD}}=10\text{V}, V_{\text{G}}=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$,

Test circuit

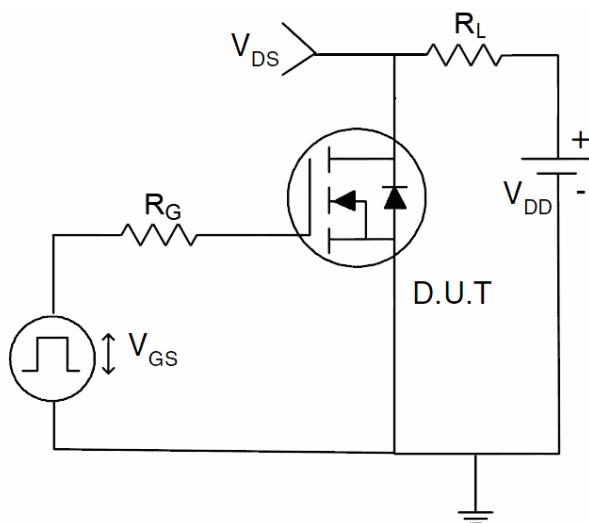
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

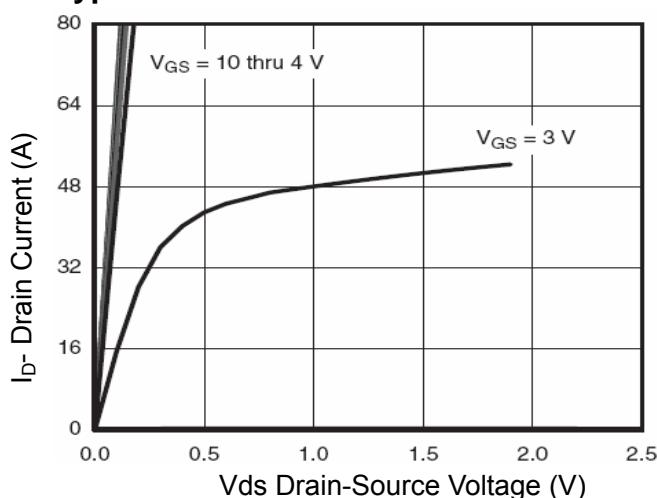


Figure 1 Output Characteristics

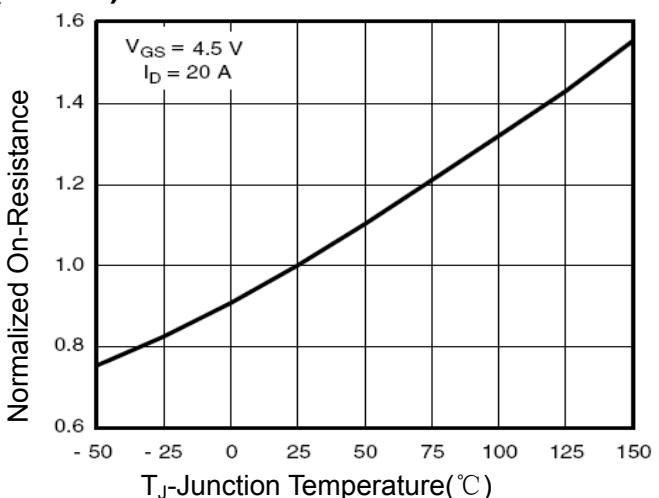


Figure 4 Rdson-JunctionTemperature

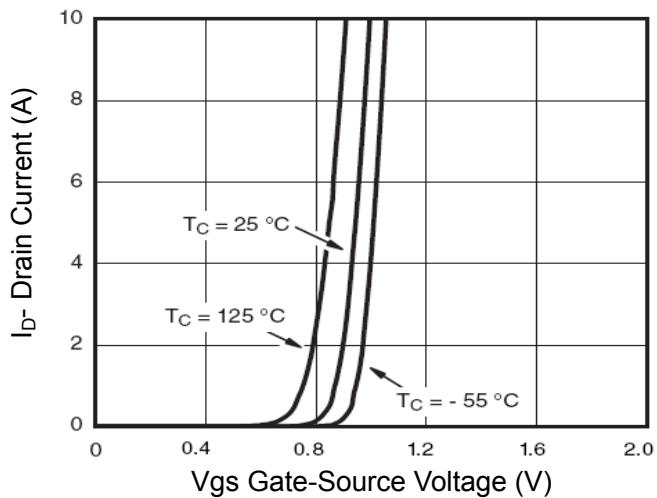


Figure 2 Transfer Characteristics

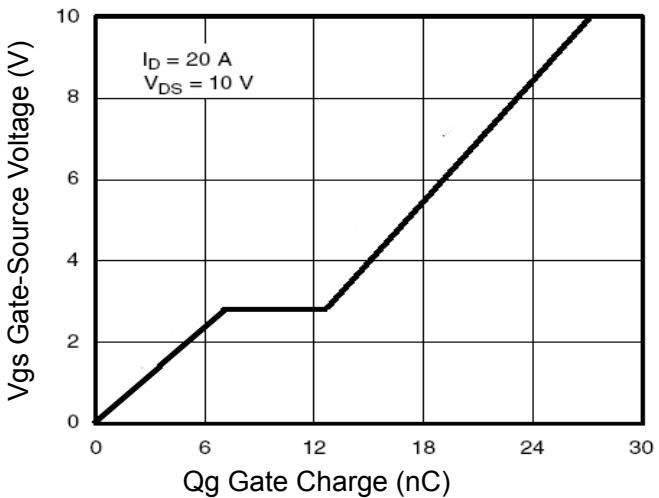


Figure 5 Gate Charge

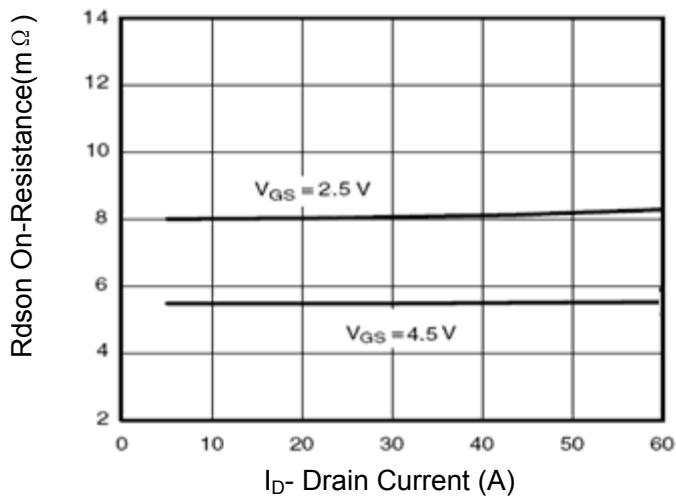


Figure 3 Rdson- Drain Current

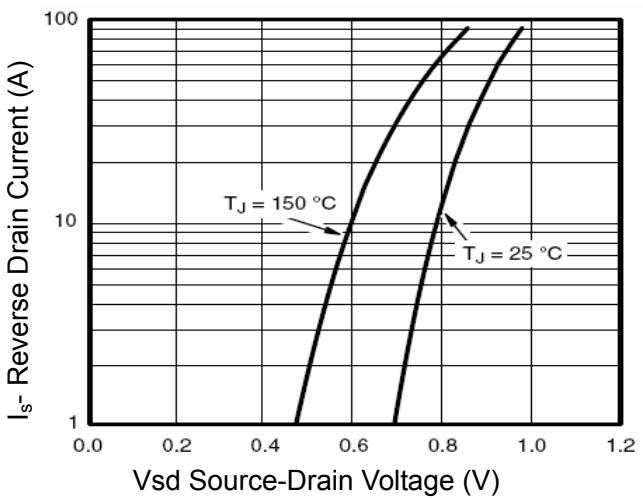


Figure 6 Source- Drain Diode Forward

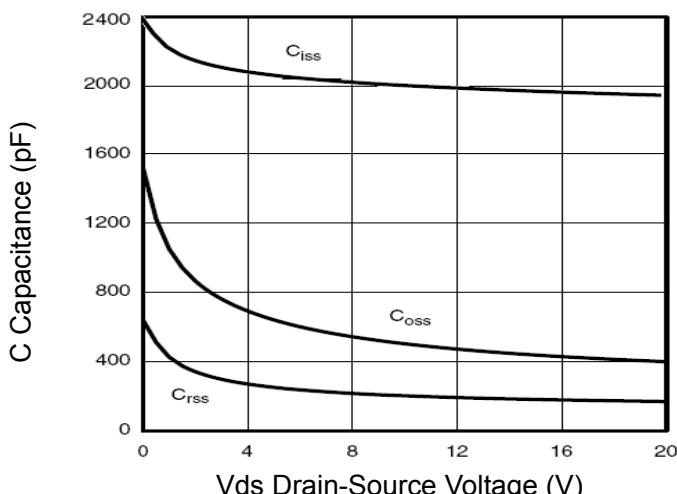


Figure 7 Capacitance vs Vds

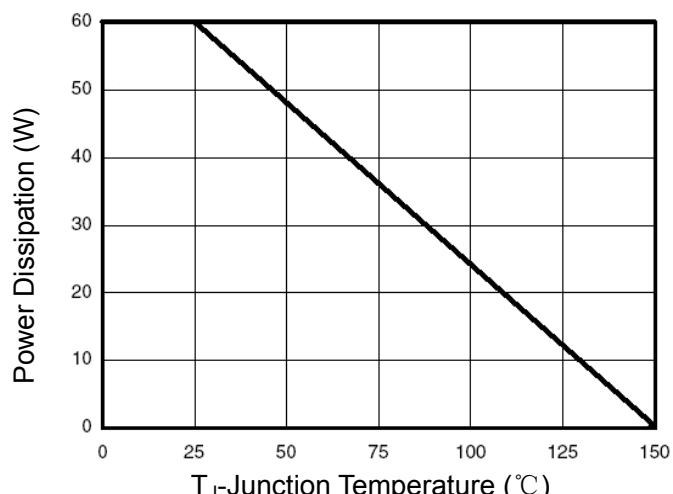


Figure 9 Power De-rating

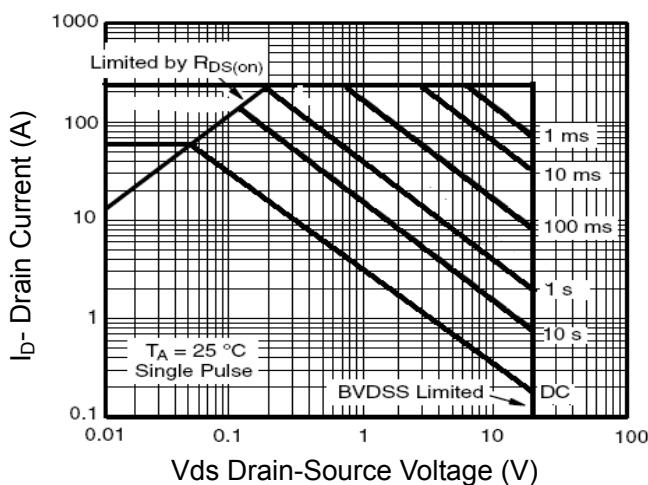


Figure 8 Safe Operation Area

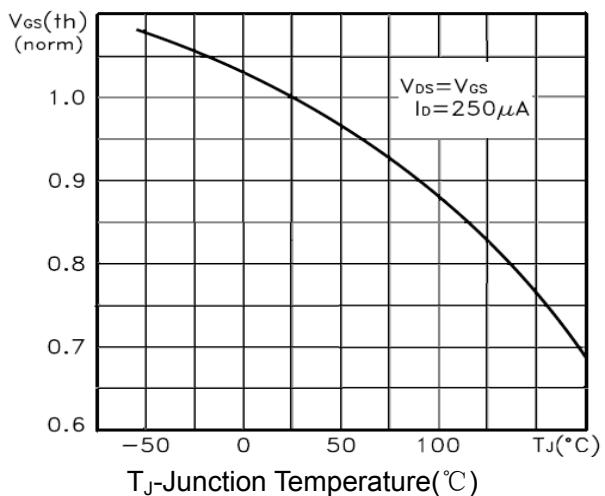


Figure 10 $V_{GS(th)}$ vs Junction Temperature

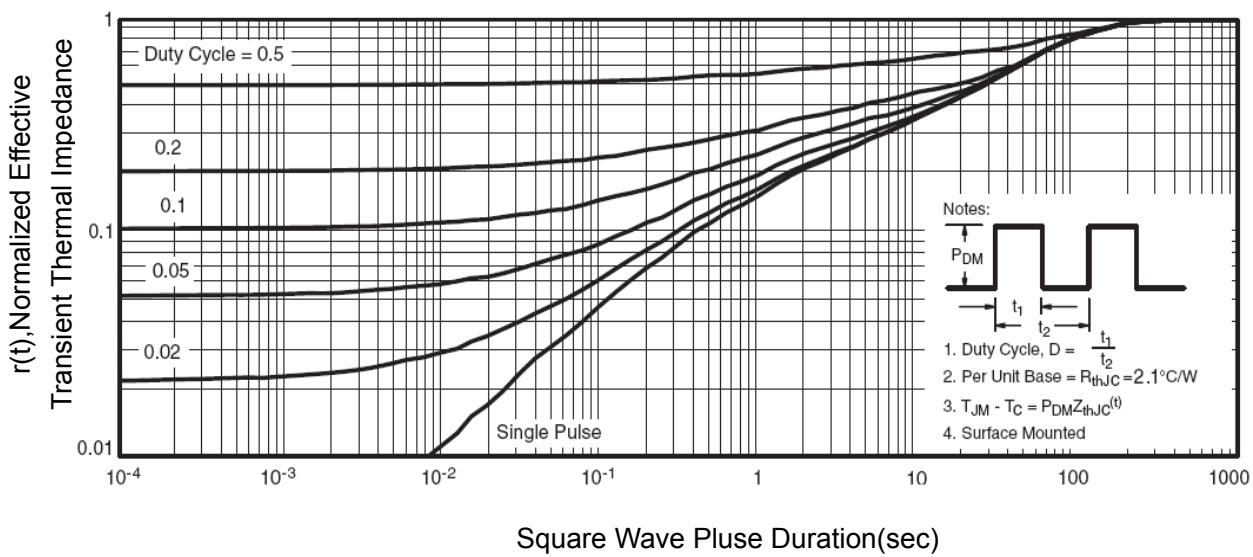
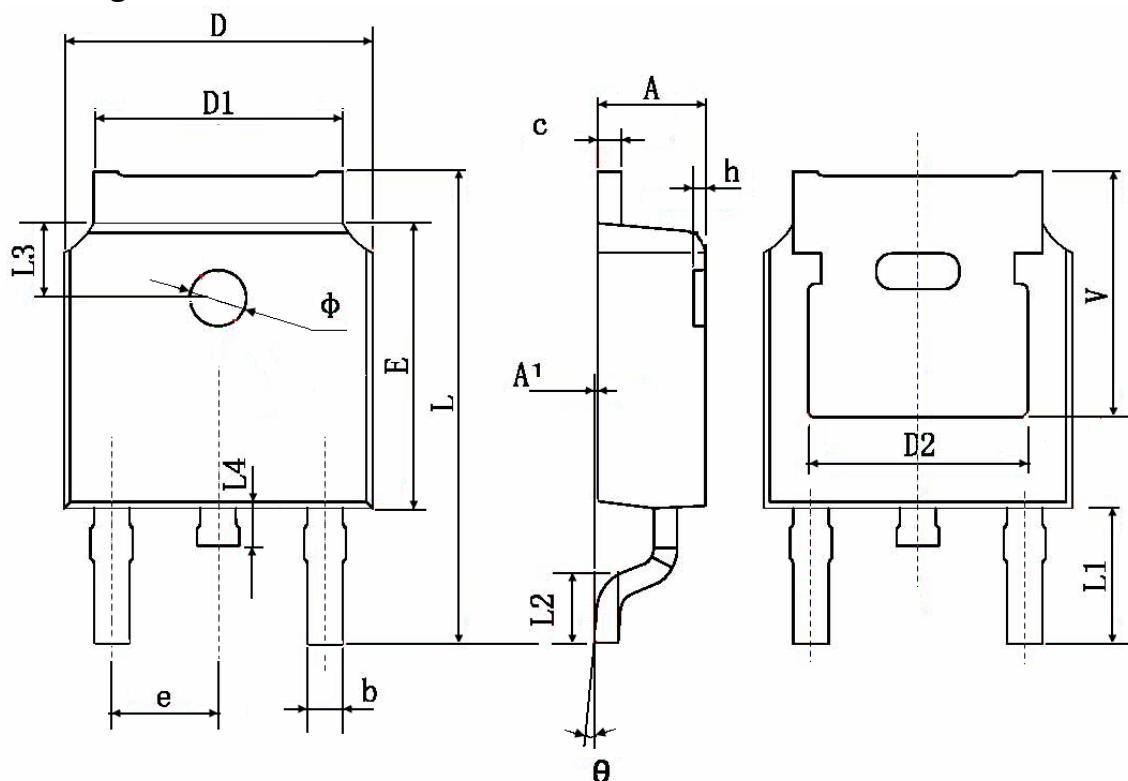


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252 Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.200 | 2.400 | 0.087 | 0.094 |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 |
| b | 0.660 | 0.860 | 0.026 | 0.034 |
| c | 0.460 | 0.580 | 0.018 | 0.023 |
| D | 6.500 | 6.700 | 0.256 | 0.264 |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 |
| D2 | 0.483 TYP. | | 0.190 TYP. | |
| E | 6.000 | 6.200 | 0.236 | 0.244 |
| e | 2.186 | 2.386 | 0.086 | 0.094 |
| L | 9.800 | 10.400 | 0.386 | 0.409 |
| L1 | 2.900 TYP. | | 0.114 TYP. | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 |
| L3 | 1.600 TYP. | | 0.063 TYP. | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 |
| Φ | 1.100 | 1.300 | 0.043 | 0.051 |
| θ | 0° | 8° | 0° | 8° |
| h | 0.000 | 0.300 | 0.000 | 0.012 |
| V | 5.350 TYP. | | 0.211 TYP. | |